

Manufacturing and Test Capabilities

	Printed Circuit Board Assembly Circuit Card Assembly	System Integration ("Box Build")	Interconnect	Customer Support
Overview	 Attachment of various electronic components onto a laminated printed circuit board. 	• Assembly of multiple circuit boards and components into a completed subassembly or in the final enclosure.	 Manufacture of a wide variety of cable and harness products 	 Diverse customer support capabilities
Capabilities	 Extend from basic to complex, high density, mixed signal boards routing RF, analog, digital and power signals. Diverse surface mount (QFPs, uBGAs, CSPs, CCGAs, BGAs, PoP, CoB) , high power through hole and solder (selective, wave and vapor) capabilities Expertise in various chemistries (aqueous cleaning, no-clean processing, IPC class 2 and 3, conformal coating and epoxy potting / encapsulation) Continuous, contiguous, automatic and cellular line configurations to a wide range of volumes and product mixes X-Ray, AOI / SPI, ICT, Flying Probe, Boundary Scan, Functional Test, HALT / HASS, ESS 	 Assemble electronic and electromechanical systems Variety of enclosure types, including sheet metal, cast and plastic enclosures Variety of applications from wearable medical devices to diagnostic systems. Serving power control and power conversion, motion control, pneumatics, vacuum and hydraulics sub-systems applications Advanced capabilities to serve a range of complex applications, including RF, optics and LED Develop test systems and test components, PCBAs, boxes and cable assemblies to numerous ISO, industry and customer requirements 	 Simple and multi-conductor wiring kits and cable assemblies Produce flat and ribbon cables, in addition to coaxial and RF cable assemblies Offer simple to complex harness assemblies 	 Direct fulfillment and configure-to-order capabilities, ensuring flexible response times and world class customer support Global logistics support, end user packaging and finished goods stocking programs Repair and refurbishment services, including logistics and reverse logistics Materials obsolescence management and Value Analysis / Value Engineering (VA/VE) to ensure viability of current programs and extend legacy programs' life cycle while minimizing component risk and cost









